EAST Search History

EAST Search History (Prior Art)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1291670	frame same wafer same contact\$3 sane laser	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:10
L2	157	frame same wafer same contact\$3 same laser	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:10
L3	48	frame same wafer same contact\$3 same laser and transparent	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:10
L4	0	frame same wafer same contact\$3 same laser and transparent not 3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:10
L5	44	("3165818" "3626141" "3811182" "3816700" "3824678" "3851758").PN. OR ("4046985").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/06/22 14:14
L6	13	[("20020029639" "20030217915" "5483095" "5895233" "6229190" "6335559" "6346742" "6521477").PN. OR ["6762072").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/06/22 14:17
L7	5	("6130401" "6580054" "6770842" "7304265" "7396780").PN. OR ("7655541").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/06/22 14:18
L8	4	frame same wafer same contact\$3 same laser adj diode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM TDB	OR	ON	2010/06/22 14:18

L9	407	(hold\$3 frame) same wafer same contact\$3 same laser	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:19
L10	10365332	@ad>"20031203" @prad>"20031203" @rlad>"20031203"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:41
L11	230	(hold\$3 frame) same wafer same contact\$3 same laser not L10	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:41
L12	217	(hold\$3 frame) same water same contact\$3 same laser same (contact bump solder) not L10	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 14:41
L13	14	("4870288" "4891526" "4955780" "5044752" "5563798" "5917601").PN. OR ("6624433").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/06/22 14:47
S3	10365332	@ad>"20031203" @prad>"20031203" @rlad>"20031203"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 09:58
S5	61	frame and plane and wafer with (contact\$3 bonding adhes\$5 connect\$3) and position\$3 and damp\$3 and diode adj laser and pressure and parallel	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 09:59
S6	8	S5 not S3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22
S7	6	(*6762072* *5250469* *5617441*).pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/06/22 10:04

EAST Search History (Interference)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L14	1	(frame and holding and pressure and transparent and diode and wafer).clm.	US-PGPUB; USPAT	OR	ON	2010/06/22 14:51
L15	1	(frame and pressure and transparent and diode and wafer).clm.	US-PGPUB; USPAT	OR	ON	2010/06/22 14:52

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